

SPECIFICATION

• Supplier : Samsung electro-mechanics • Part Number : CL10B473MB6NXNC

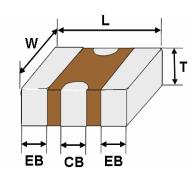
• **Product** : Multi-layer Ceramic Capacitor • **Discription** : Cap, 47nF, 50V, ±20%, X7R, 0603

A. Samsung Part Number

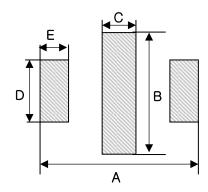
<u>CL</u> <u>10</u> <u>B</u> <u>473</u> <u>M</u> <u>B</u> <u>6</u> <u>N</u> <u>X</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor					
2	Size	0603 (inch code)	L: 1.6 ±0.1mm	W:	$0.8 \pm 0.1 \text{ mm}$		
3	Dielectric	X7R	8 Inner electrode		Ni		
4	Capacitance	47 nF	Termination		Cu		
(5)	Capacitance	±20 %	Plating		Sn 100% (Pb Free)		
	tolerance		9 Product		X2Y		
6	Rated Voltage	50 V	Special		Reserved for future use		
7	Thickness	0.6 ±0.1 mm	① Packaging		Cardboard Type, 7" reel		

B. Structure and Dimensions



	Dimmension(mm)		
L	1.6 ± 0.15		
W	0.8 ± 0.1		
T	0.6 ± 0.1		
СВ	0.45 ± 0.15		
EB	0.25 ± 0.15		



<Recommended Land pattern design>

	Dimmension(mm)		
Α	2.30		
В	1.52		
С	0.51		
D	0.89		
Ε	0.64		

C. Samsung Reliablility Test and Judgement condition

	Judgement	Test condition			
Capacitance	Within specified tolerance				
Tan δ (DF)	0.05 max.	1kHz±10% 1.0±0.2Vrms			
Insulation	100Mohm*uF min.	Rated Voltage 60~120 sec.			
Resistance		į			
Appearance	No abnormal exterior appearance	Microscope (×10)			
Withstanding	No dielectric breakdown or	250% of the rated voltage			
Voltage	mechanical breakdown				
Temperature	X7R	•			
Characterisitcs	(From -55℃ to 125℃, Capacitance change	shoud be within ±15%)			
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.			
of Termination	terminal electrode				
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm) for 5 sec.			
		with 1.0mm/sec.			
Solderability	More than 75% of terminal surface	1) Sn63Pb37 solder			
	is to be soldered newly	235±5℃, 5±0.5sec.			
		2) SnAg3.0Cu0.5 solder			
		245±5°C, 3±0.3sec.			
		(preheating : 80~120 °C for 10~30sec.)			
Resistance to	Capacitance change: within ±7.5%	Solder pot : 270±5 ℃, 10±1sec.			
Soldering heat	Tan δ, IR : initial spec.				
Vibration Test	Capacitance change : within ±5%	Amplitude: 1.5mm			
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)			
11	O	2hours × 3 direction (x, y, z)			
Humidity	Capacitance change: within ±12.5%	40±2℃, 90~95%RH, 500+12/-0hrs			
	Tan δ: 0.075 max.				
	IR : 50MohmuF min.				
Moisture	Capacitance change: within ±12.5%	With rated voltage			
Resistance	Tan δ : 0.075 max.				
Resistance	IR : 25Mohm min.	40±2 °C, 90~95%RH, 500+12/-0hrs Note: Since the residue of flux may affect resistivity,			
	IK . 25WOTHT THIT.	it is recommended to use proper solder paste and			
High Temperature	Capacitance change: within ±12.5%	cleaning fluid to remove flux residue thoroughly. With 150% of the rated voltage			
Resistance	Tan δ : 0.075 max.	Max. operating temperature			
i ve si statice	IR : 50MohmuF min.	1000+48/-0hrs			
	in Solvioninu inin.	1000 - 407-01115			
Temperature	Capacitance change : within ±7.5%	1 cycle condition			
Cycling	Tan δ, IR : initial spec. initial spec.	Min. operating temperature → 25 °C			
	·	\rightarrow Max. operating temperature \rightarrow 25 $^{\circ}$ C			
		5 cycle test			
L	J	1 -			

D. Recommended Soldering method :



Multi Layer Ceramic Capacitor (MLCC)

I . Electrical Characteristics Data

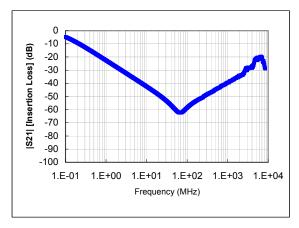
1. Model: CL10B473MB6NXNC

2. Description

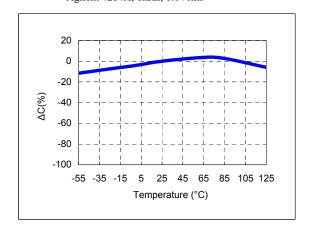
Part	Part no.	Size	Thickness	Temperature	Capacitance	Capacitance	Voltage
	i art no.	(inch(mm))	(mm)	charateristics	value(nF)	tolerance(%)	(V)
	CL10B473MB6NXNC	0603/1608	0.6mm	X7R	47nF	± 20 %	50

3. Characteristics Data

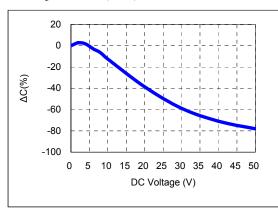
1)Frequency Characeristics Agilent 5071A, 0.1MHz to 8.5GHz



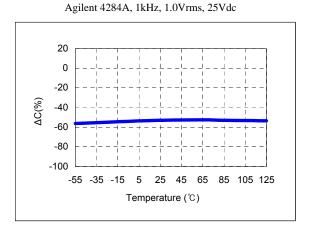
2)Temperature Characteristics (TCC) Agilent 4284A, 1kHz, 1.0Vrms



3)DC Bias Characteristics Quadtech 7600,1kHz, 1Vrms



4) Bias TCC characteristics



5)AC Voltage Characteristics Agilent 4284A,1kHz

